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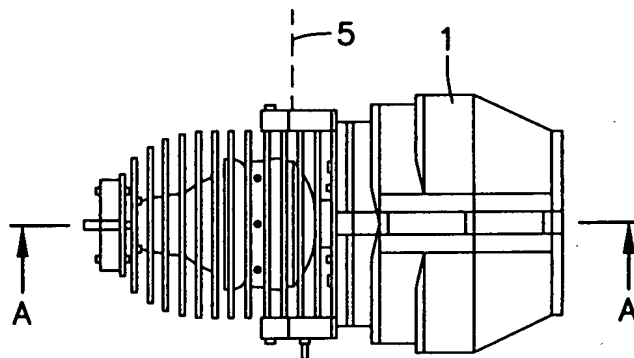


Fig. 1a

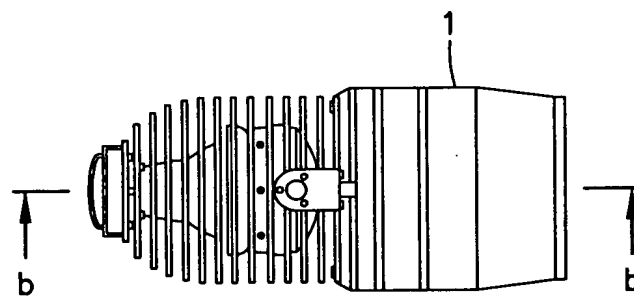
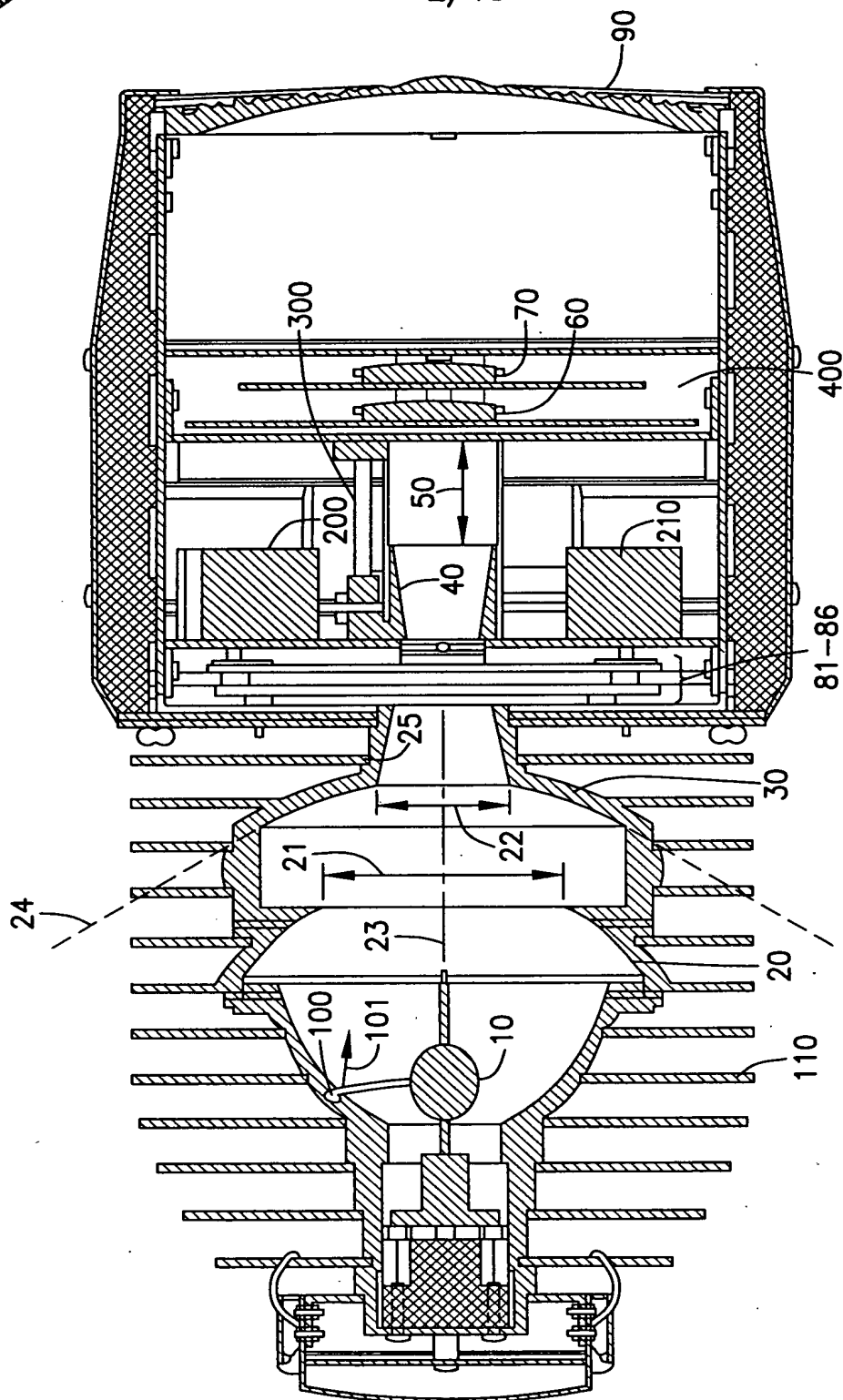


Fig. 2a



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Fig. 1b



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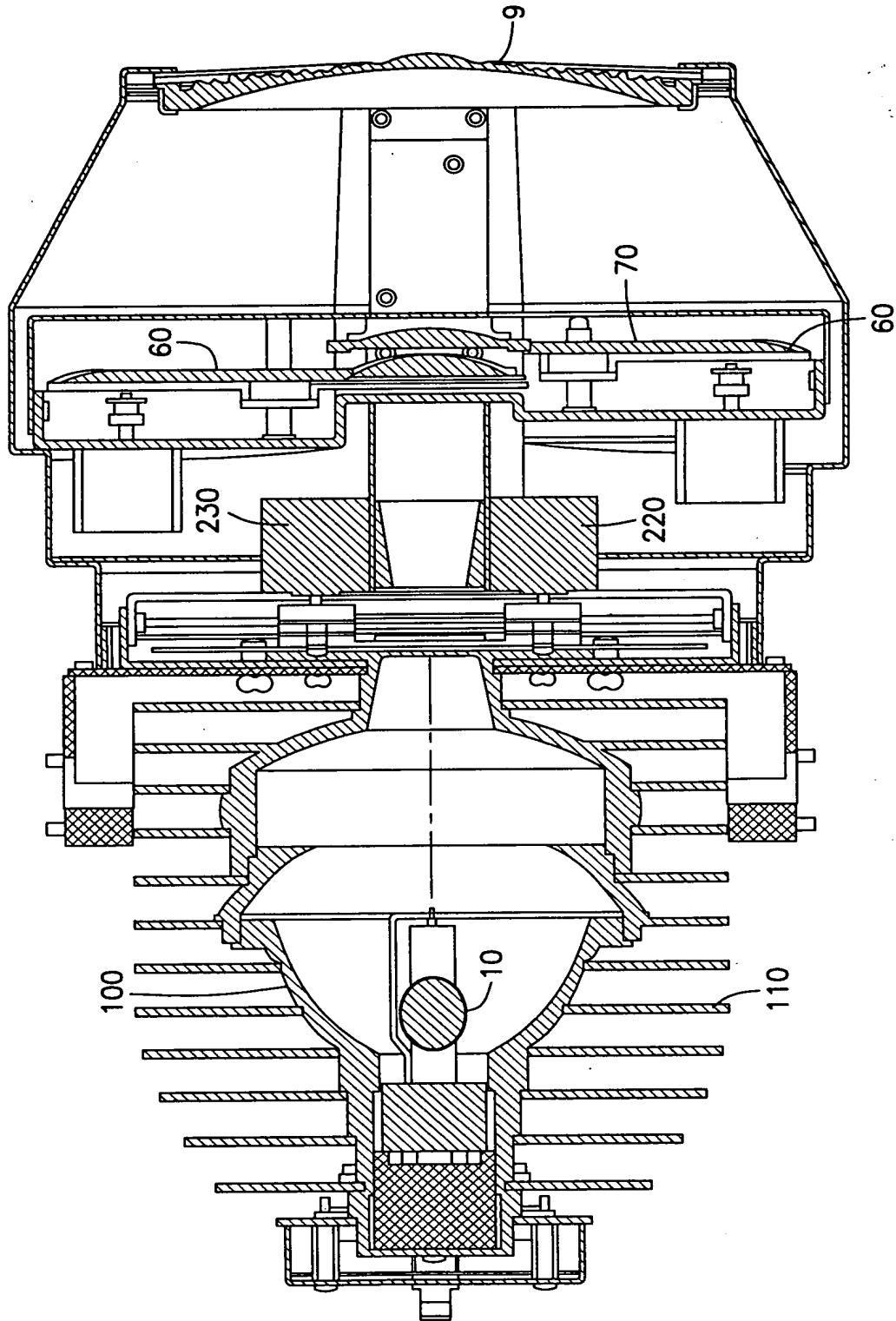


Fig. 2b



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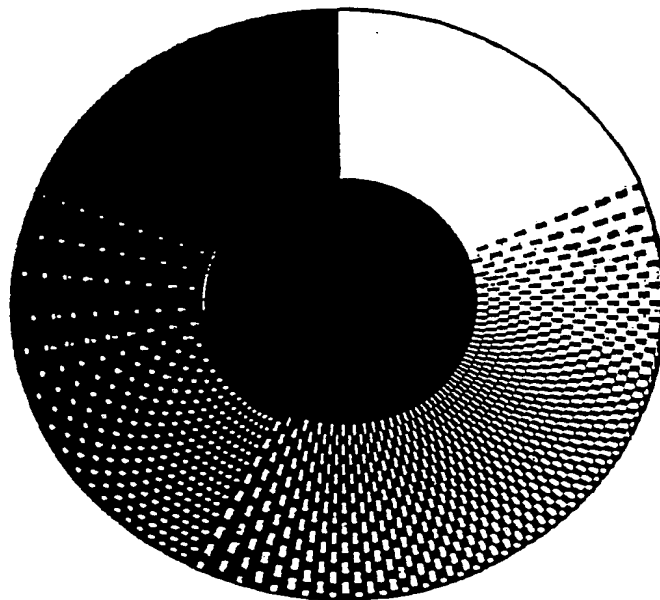


Fig. 3



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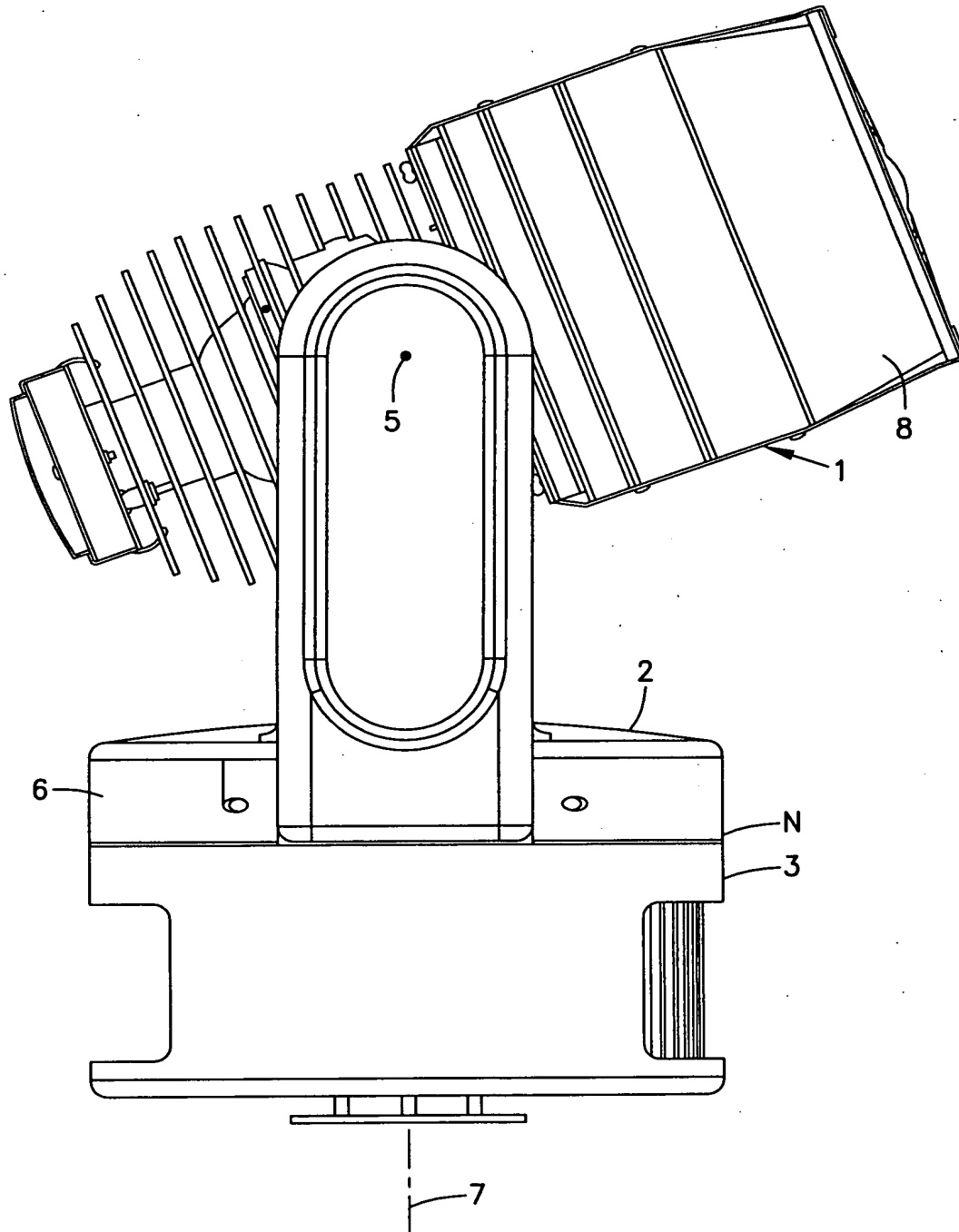


Fig. 4



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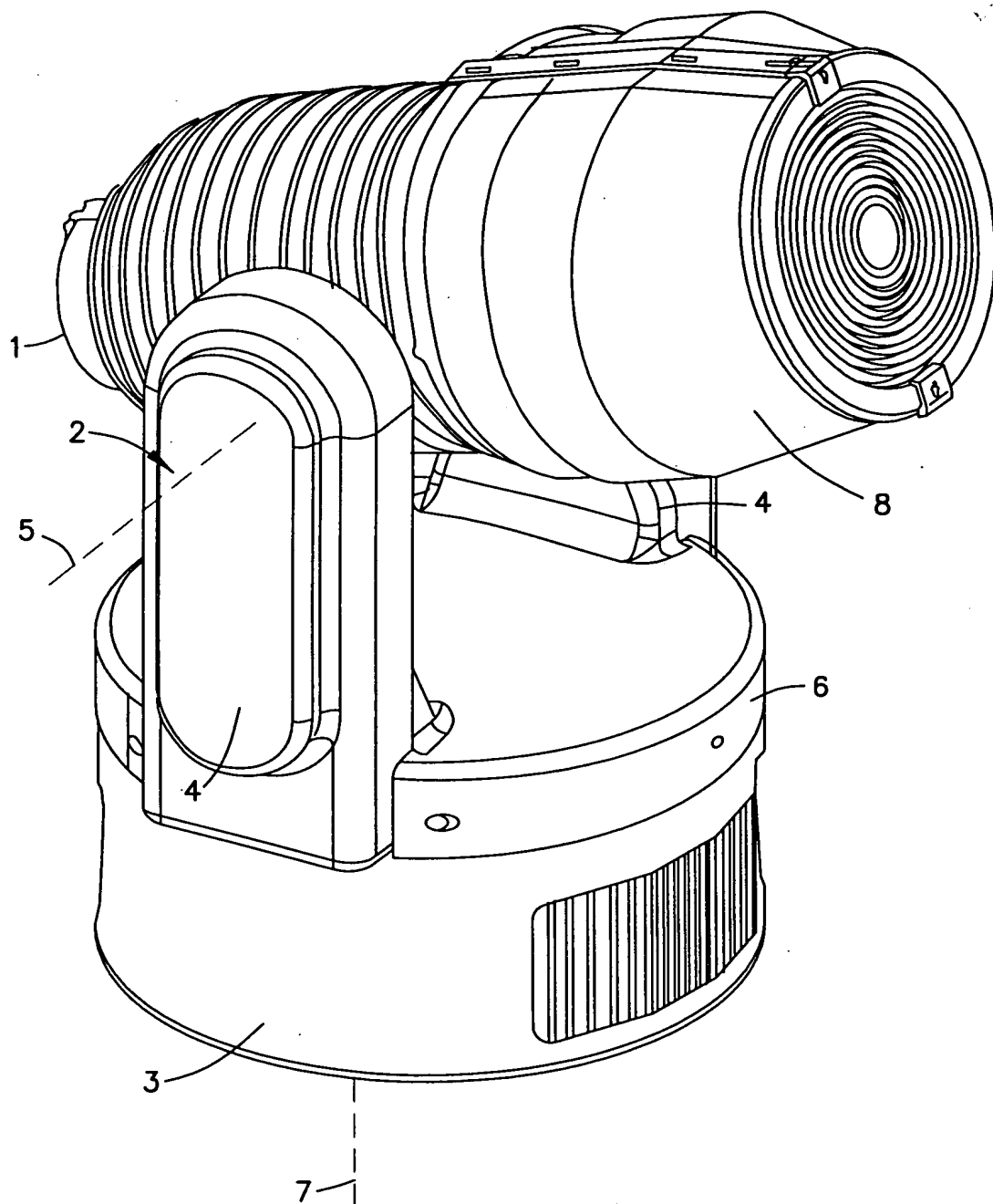


Fig. 5



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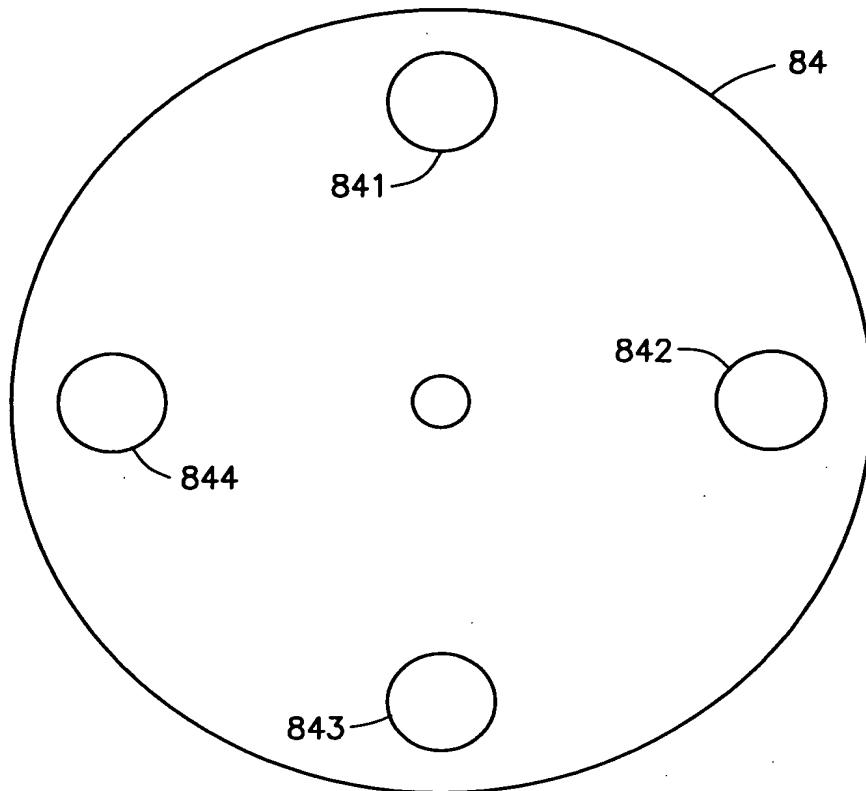


Fig. 6



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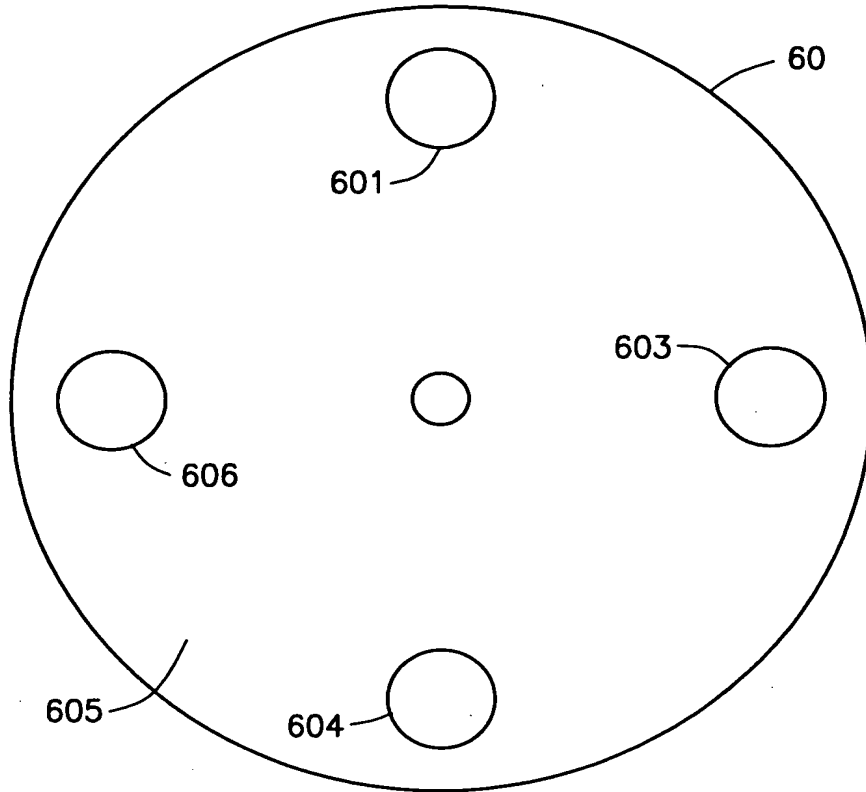


Fig. 7a



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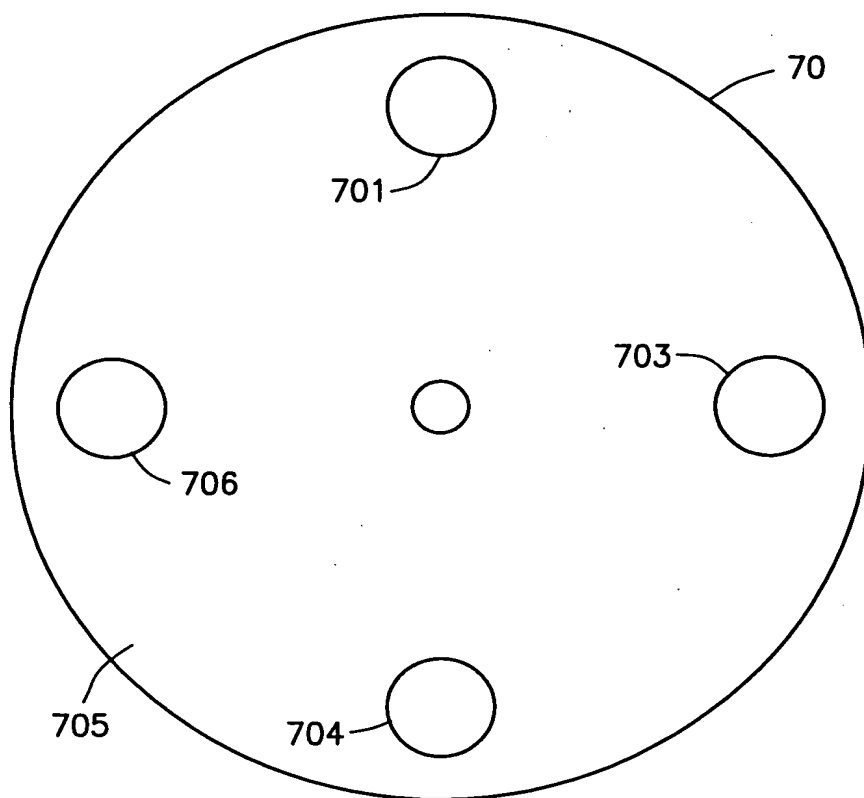


Fig. 7b



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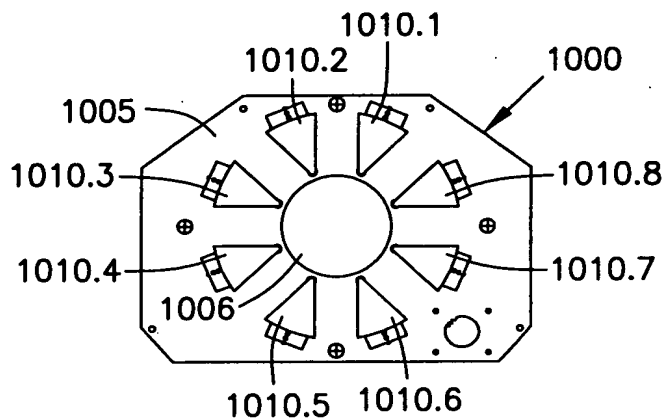


Fig. 8a

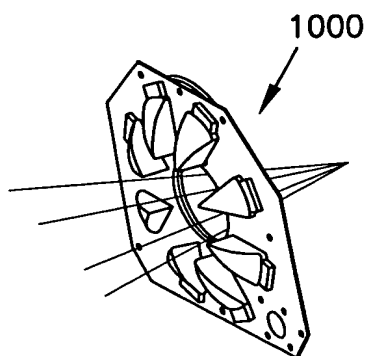


Fig. 8b

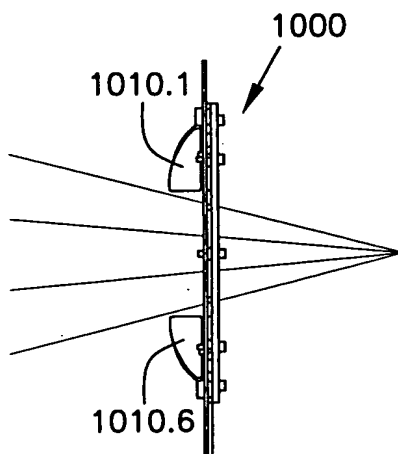


Fig. 8c



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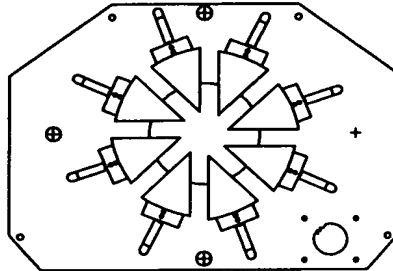


Fig. 9a

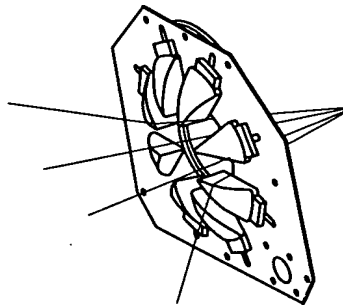


Fig. 9b

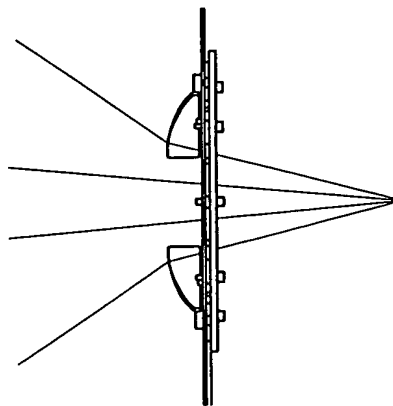


Fig. 9c



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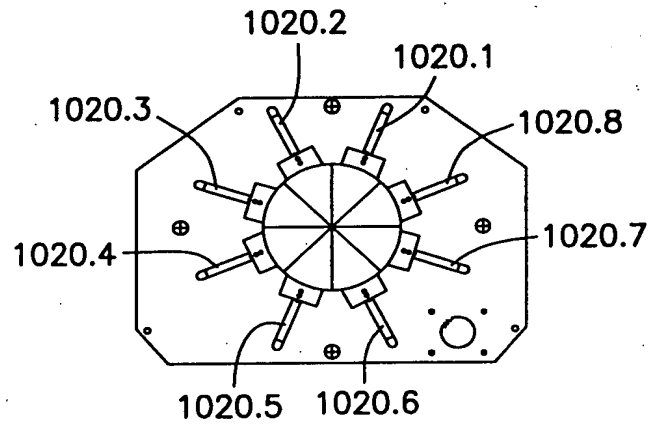


Fig. 10a

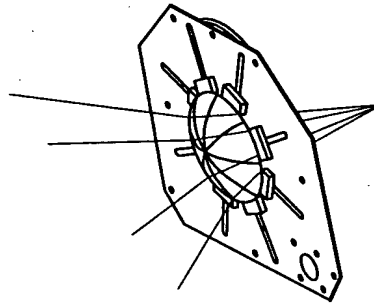


Fig. 10b

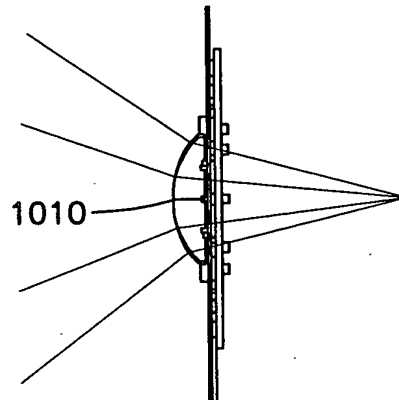


Fig. 10c



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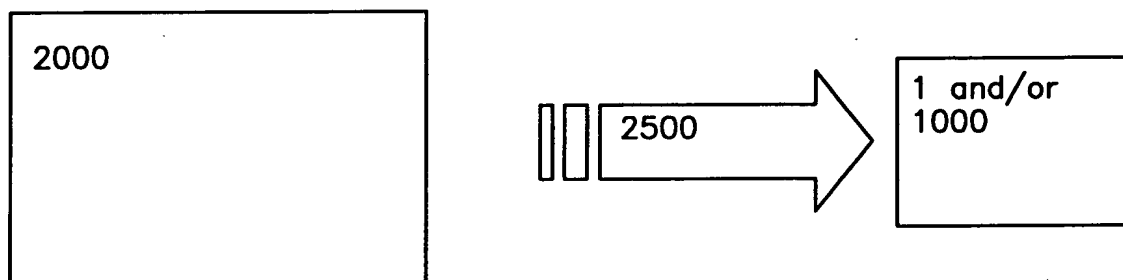


Fig. 11